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IGBT Module

BSM 200 GA 100 D

Preliminary Data

 $V_{\rm CE}$ = 1000 V

 $I_{\rm C}=275~{\rm A}$ at $T_{\rm C}=25~{\rm ^{\circ}C}$

 $I_{\rm C}$ = 200 A at $T_{\rm C}$ = 80 °C

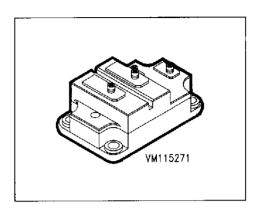
Power module

Single switch

Including fast free-wheel diodes

Package with insulated metal base plate

Package outlines/Circuit diagram: 4¹⁾



Single switch					
Туре	Ordering Code				
BSM 200 GA 100 D	C67076-A2001-A2				

Maximum Ratings

Parameter	Symbol	Values	Unit	
Collector-emitter voltage	V_{CE}	1000	V	
Collector-gate voltage, $R_{\rm GE}$ = 20 k Ω	$V_{\sf CGR}$	1000		
Gate-emitter voltage	V_{GE}	± 20		
Continuous collector current, $T_{\rm C}$ = 25 °C $T_{\rm C}$ = 80 °C	I_{C}	275 200	A	
Pulsed collector current, $T_{\rm C}$ = 25 °C $T_{\rm C}$ = 80 °C	I _{C puls}	550 400		
Operating and storage temperature range	$T_{\rm j},T_{\rm stg}$	- 55 + 150	Ĉ	
Power dissipation, $T_{\rm C}$ = 25 °C	P _{tot}	1750	W	
Thermal resistance, chip-case	R_{thJC}	≤ 0.07	K/W	
Insulation test voltage ²⁾ , $t = 1$ min.	V_{is}	2500	V _{ac}	
Creepage distance	_	16	mm	
Clearance	_	11		
DIN humidity category, DIN 40 040	_	F		
IEC climatic category, DIN IEC 68-1	_	55/150/56		

See chapter Package Outline and Circuit Diagrams

Insulation test voltage between collector and metal base plate referred to standard climate 23/50 in acc. with DIN 50 014, IEC 146, para. 492.1



Electrical Characteristics

at $T_1 = 25$ °C, unless otherwise specified.

Parameter	Symbol		Values		Unit
		min.	typ.	max.	
Static Characteristics					
Collector-emitter breakdown voltage $V_{ m GE}$ = 0, $I_{ m C}$ = 4 mA	$V_{(BR)CES}$	1000	_	_	V
Gate threshold voltage $V_{\rm GE}$ = $V_{\rm CE}$, $I_{\rm C}$ = 16 mA	$V_{GE(th)}$	4.8	5.5	6.2	
Collector-emitter saturation voltage $V_{\rm GE}$ = 15 V, $I_{\rm C}$ = 200 A	$V_{CE(sat)}$				
$T_{\perp} = 25 ^{\circ}\text{C}$ $T_{\perp} = 150 ^{\circ}\text{C}$		_	2.8 4.0	3.3 4.5	
Zero gate voltage collector current $V_{\rm CE}$ = 1000 V, $V_{\rm GE}$ = 0	$I_{ m CES}$				μА
$T_{\text{J}} = 25 ^{\circ}\text{C}$ $T_{\text{J}} = 125 ^{\circ}\text{C}$		_	_	4000	
Gate-emitter leakage current V_{GE} = 20 V, V_{CE} = 0	I_{GES}	_	_	100	лA
AC Characteristics					
Forward transconductance $V_{\rm CE}$ = 20 V, $I_{\rm C}$ = 200 A	Sts	72		_	S
Input capacitance V_{CE} = 25 V, V_{GE} = 0, f = 1 MHz	C_{iss}	_	32000		pF
Output capacitance, $V_{\rm GS}$ = 0 $V_{\rm CE}$ = 25 V, $V_{\rm GE}$ = 0, f = 1 MHz	$C_{ m oss}$	_	2600	_	
Reverse transfer capacitance $V_{\rm CE}$ = 25 V, $V_{\rm GE}$ = 0, f = 1 MHz	C_{rss}	_	1000		



Switching Characteristics

at $T_1 = 125$ °C, unless otherwise specified.

Parameter	Symbol	Values			Uni
		min.	typ.	max.	
Resistive Load					
Turn-on delay time	t _{d (on)}				ns
$V_{\rm CC} = 600 \text{ V}, \ V_{\rm GE} = 15 \text{ V}, \ I_{\rm C} = 200 \text{ A} \ R_{\rm g (on)} = 3.3 \Omega, \ R_{\rm g (off)} = 3.3 \Omega$		_	200	_	
Rise time	t _r				
$V_{\rm CC}$ = 600 V, $V_{\rm GE}$ = 15 V, $I_{\rm C}$ = 200 A $R_{\rm g~(on)}$ = 3.3 Ω , $R_{\rm g~(off)}$ = 3.3 Ω		_	440	_	
Turn-off delay time	t _{d (off)}				
$V_{\rm CC}$ = 600 V, $V_{\rm GE}$ = 15 V, $I_{\rm C}$ = 200 A $R_{\rm g~(on)}$ = 3.3 Ω , $R_{\rm g~(off)}$ = 3.3 Ω		_	730		
Fall time	t _f				
$V_{\rm CC}$ = 600 V, $V_{\rm GE}$ = 15 V, $I_{\rm C}$ = 200 A $R_{\rm g~(on)}$ = 3.3 Ω , $R_{\rm g~(off)}$ = 3.3 Ω		_	500	_	

Inductive Load

inductive Load					
Turn-on delay time $V_{\text{CC}} = 600 \text{ V}, V_{\text{GE}} = 15 \text{ V}, I_{\text{C}} = 200 \text{ A}$	t _{d (on)}	120	200	250	ns
$R_{g \text{ (on)}} = 3.3 \Omega, R_{g \text{ (off)}} = 3.3 \Omega$		120	200	230	
Rise time	$t_{\rm r}$				
$V_{\rm CC}$ = 600 V, $V_{\rm GE}$ = 15 V, $I_{\rm C}$ = 200 A $R_{\rm g~(on)}$ = 3.3 Ω , $R_{\rm g~(off)}$ = 3.3 Ω		45	90	140	
Turn-off delay time $V_{\rm CC}$ = 600 V, $V_{\rm GE}$ = 15 V, $I_{\rm C}$ = 200 A	t _{d (off)}				
$R_{g \text{ (on)}} = 3.3 \Omega, R_{g \text{ (off)}} = 3.3 \Omega$		550	730	900	
Fall time $V_{\rm CC}$ = 600 V, $V_{\rm GE}$ = 15 V, $I_{\rm C}$ = 200 A	t_{f}				
$R_{\rm g (on)} = 3.3 \Omega, R_{\rm g (off)} = 3.3 \Omega$		80	110	140	
Turn-off loss ($E_{\text{off}} = E_{\text{off 1}} + E_{\text{pff 2}}$)	$E_{ m off,1}$	_	15	_	mWs
$V_{\rm CC}$ = 600 V, $V_{\rm GE}$ = 15 V, $I_{\rm C}$ = 200 A $R_{\rm g~(on)}$ = 3.3 Ω , $R_{\rm g~(off)}$ = 3.3 Ω	E _{off 2}	_	10	_	



Electrical Characteristics

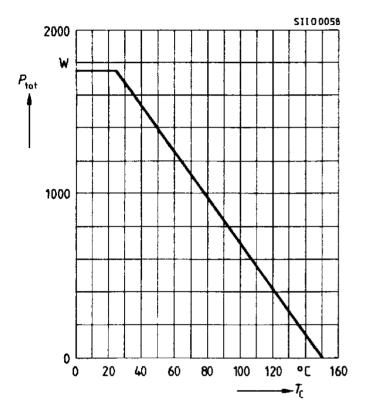
at $T_{\rm j}$ = 25 °C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Free-Wheel Diode					
Diode forward voltage $I_F = 200 \text{ A}, V_{GE} = 0$ $T_J = 25 ^{\circ}\text{C}$ $T_L = 125 ^{\circ}\text{C}$	V_{F}	-	1.85 1.45		V
Reverse recovery time $I_{\rm F}=200$ A, $V_{\rm R}=600$ V $V_{\rm GE}=0$, ${\rm d}i_{\rm F}/{\rm d}t=-800$ A/ μ s $T_{\rm I}=125$ °C	t _{rr}	_	0.4	_	μs
Reverse recovery charge $I_{\rm F}=200$ A, $V_{\rm R}=600$ V $V_{\rm GE}=0$, ${\rm d}i_{\rm F}/{\rm d}t=-3000$ A/ μ s $T_{\rm J}=25$ °C $T_{\rm J}=125$ °C	Q_{rr}	 - -	12 36		μС
Soft factor $I_F = 200 \text{ A}, V_B = 600 \text{ V}$ $V_{GE} = 0, di_F/dt = -3000 \text{ A}/\mu\text{s}$ $T_J = 125 ^{\circ}\text{C}$	S	_	1	_	_
Thermal resistance Chip-case	R_{thJC}	_	_	0.25	K/W

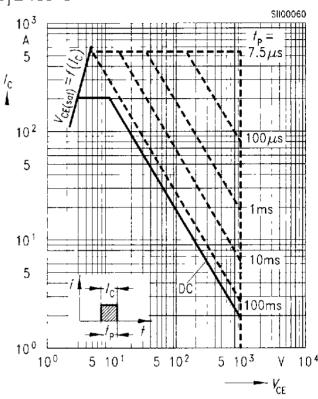
Characteristics at T_1 = 25 °C, unless otherwise specified.

Power dissipation $P_{\text{tot}} = f(T_{\text{C}})$

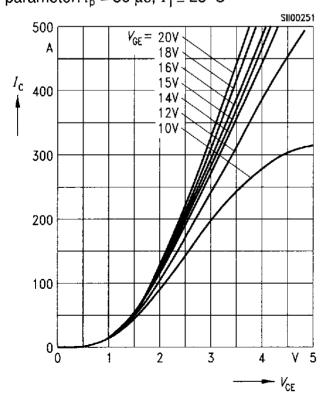
parameter: $T_1 = 150 \, ^{\circ}\text{C}$



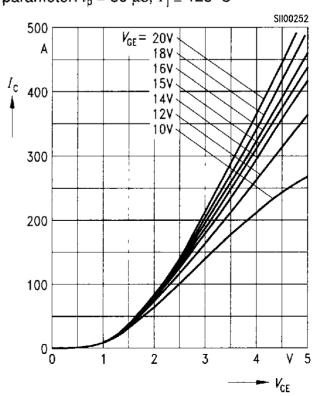
Safe operating area $I_{\rm C}$ = $f(V_{\rm CE})$ parameter: single pulse, $T_{\rm C}$ = 25 °C $T_{\rm I} \le$ 150 °C



Typ. output characteristics $I_{\rm C}$ = $f(V_{\rm CE})$ parameter: $t_{\rm p}$ = 80 μ s, $T_{\rm J}$ ≤ 25 $^{\circ}$ C



Typ. output characteristics $I_{\rm C} = f(V_{\rm CE})$ parameter: $t_{\rm p} = 80~\mu \rm s,~T_{\rm l} \le 125~^{\circ}C$

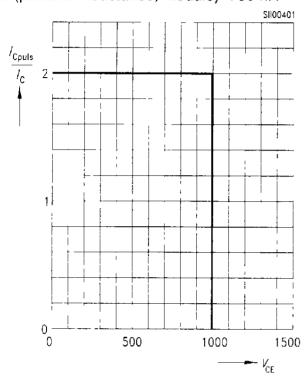


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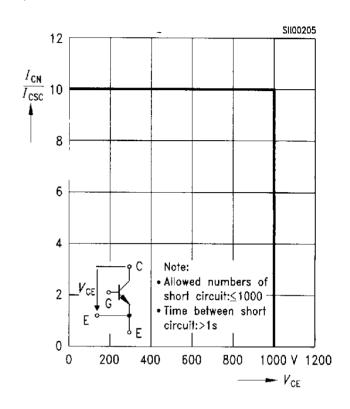
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Reverse biased safe operating area

 $I_{\rm C}$ = f ($V_{\rm CE}$), parameter: $T_{\rm J}$ = 125 °C, $V_{\rm GE}$ = 15 V, $R_{\rm g(off)}$ = 3.3 Ω , L (parastic inductance, module) < 50 nH

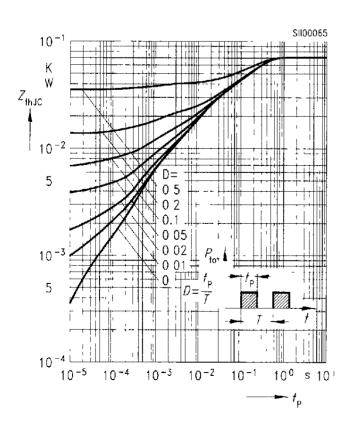


Safe operating area, short circuit $I_{\rm C}$ = f ($V_{\rm CE}$), $V_{\rm GE}$ = \pm 15 V $T_{\rm I} \leq$ 150 °C, $t_{\rm SC} \leq$ 10 μ s, L < 80 nH



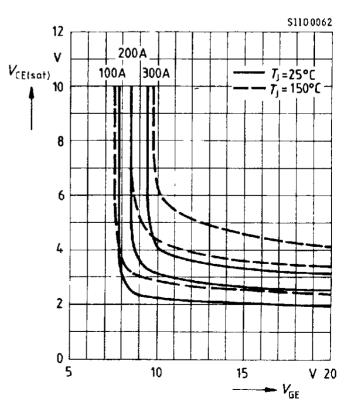
Transient thermal impedance

 $Z_{thJC} = f(t_p)$, parameter: $D = t_p / T$

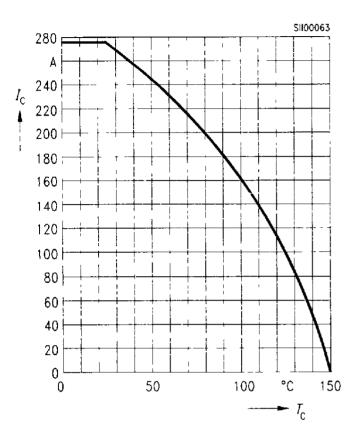


Typ. on-state characteristics

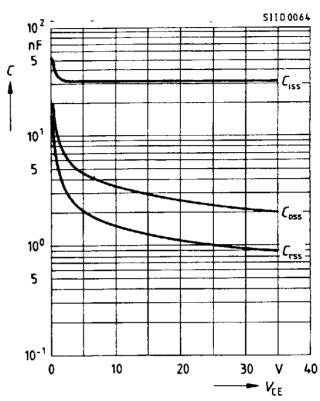
 $V_{\text{CE (sat)}} = f(V_{\text{GE}})$, parameter: I_{C} , T_{J}



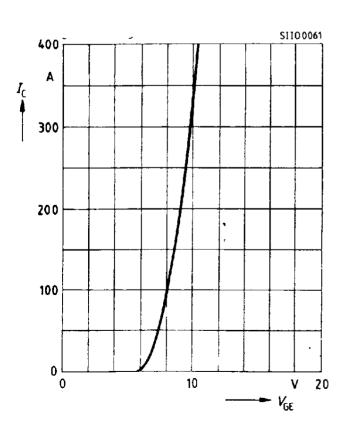
Collector current $I_{\rm C} = f(T_{\rm C})$ parameter: $V_{\rm GE} \ge 15 \text{ V}$, $T_{\rm I} = 150 \,^{\circ}\text{C}$



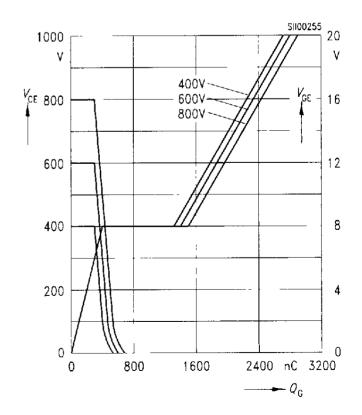
Typ. capacitances $C = f(V_{CE})$ parameter: $V_{GE} = 0, f = 1 \text{ MHz}$



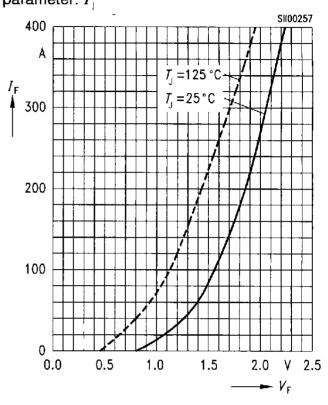
Typ. transfer characteristics $I_{\rm C}$ = $f(V_{\rm GE})$ parameter: $t_{\rm p}$ = 80 μ s, $V_{\rm CE}$ = 20 V



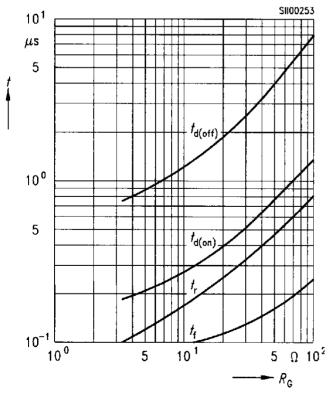
Typ. gate charge $V_{\rm CE},\,V_{\rm GE}$ = $f(Q_{\rm G})$



Forward characteristics of fast recovery reverse diode $I_F = f(V_F)$ parameter: T_{\parallel}



Typ. switching time $t = f(R_{\rm G})$ Inductive load, parameter: $T_{\rm j} =$ 125 °C $V_{\rm CE} =$ 600 V, $V_{\rm GE} = \pm$ 15 V, $I_{\rm C} =$ 200 A



Typ. switching time $t = f(I_{\rm C})$ Inductive load, parameter: $T_{\rm j} = 125~{\rm ^{\circ}C}$ $V_{\rm CE} = 600~{\rm V}, V_{\rm GE} = \pm~15~{\rm V}, R_{\rm G} = 3.3~{\rm \Omega}$

